### 

# PJN1NA50 / PJW1NA50 / PJU1NA50 / PJD1NA50

1 A

Current

### **500V N-Channel MOSFET**

500 V

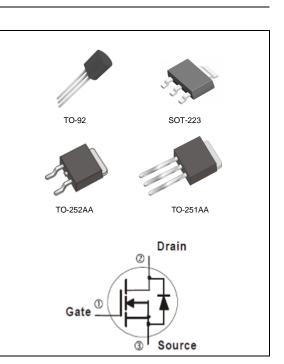
#### Voltage

#### Features

- R<sub>DS(ON)</sub>, V<sub>GS</sub>@10V, I<sub>D</sub>@0.5A<9Ω</li>
- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

#### **Mechanical Data**

- Case : TO-251AA, TO-252AA, SOT-223, TO-92 Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- TO-251AA Approx. Weight : 0.0104 ounces, 0.297grams
- TO-252AA Approx. Weight : 0.0104 ounces, 0.297grams
- SOT-223 Approx. Weight : 0.043 ounces, 0.123grams
- TO-92 Approx. Weight : 0.007 ounces, 0.196grams



#### **Maximum Ratings and Thermal Characteristics** ( $T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER		SYMBOL	TO-251AA	TO-252AA	SOT-223	TO-92	UNITS
Drain-Source Voltage		V <sub>DS</sub>	500				V
Gate-Source Voltage		$V_{GS}$	<u>+</u> 30				V
Continuous Drain Current		I <sub>D</sub>	1 0.3		.3	А	
Pulsed Drain Current		I <sub>DM</sub>	4 1.2		.2	А	
Single Pulse Avalanche Energy (Note 1)		E <sub>AS</sub>	42				mJ
Power Dissipation	T <sub>C</sub> =25°C	P <sub>D</sub>	2	:5	3.3	3	W
	Derate above 25°C		0	.2	0.026	0.024	W/°C
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~150			°C	
Typical Thermal resistance							
- Junction to Case		$R_{ extsf{ heta}JC}$	ę	5	-	-	°C/W
- Junction to Ambient		$R_{ extsf{ heta}JA}$	1 <sup>.</sup>	10	37.9 <sup>(Note 4)</sup>	140	

• Limited only By Maximum Junction Temperature





### **Electrical Characteristics** ( $T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	$BV_{DSS}$	V <sub>GS</sub> =0V,I <sub>D</sub> =250uA	500	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	2	3.02	4	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V,I <sub>D</sub> =0.5A	-	7.6	9	Ω
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =500V,V <sub>GS</sub> =0V	-	0.02	1.0	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = <u>+</u> 30V,V <sub>DS</sub> =0V	-	<u>+</u> 20	<u>+</u> 100	nA
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> =1A,V <sub>GS</sub> =0V	-	0.86	1.4	V
Dynamic (Note 5)						
Total Gate Charge	$Q_g$	V 400V I 44	-	4.2	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =400V, I <sub>D</sub> =1A, V <sub>GS</sub> =10V <sup>(Note 2,3)</sup>	-	1.7	-	
Gate-Drain Charge	$Q_gd$	V <sub>GS</sub> =10V	-	1.4	-	
Input Capacitance	Ciss	Ciss		95	-	
Output Capacitance	Coss	$V_{DS}=25V, V_{GS}=0V,$	-	23	-	pF
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	0.3	-	
Furn-On Delay Time td <sub>(on)</sub>			-	5	-	
Turn-On Rise Time	t <sub>r</sub>	$V_{DD}=250V, I_{D}=1A,$ $R_{G}=25\Omega^{(Note 2,3)}$	-	20	-	ns
Turn-Off Delay Time	td <sub>(off)</sub>		-	8	-	
Turn-Off Fall Time	t <sub>f</sub>		-	24	-	
Drain-Source Diode		·				
Maximum Continuous Drain-Source			-	-	1	A
Diode Forward Current	۱ <sub>S</sub>					
Aximum Pulsed Drain-Source					4	
Diode Forward Current	I <sub>SM</sub>		-	-	4	A
Reverse Recovery Time	trr	V <sub>GS</sub> =0V, I <sub>S</sub> =1A	-	155	-	ns
Reverse Recovery Charge	Qrr	dI <sub>F</sub> / dt=100A/us <sup>(Note 2)</sup>	-	0.53	-	uC

NOTES :

1. L=30mH,  $I_{AS}$ =1.6A,  $V_{DD}$ =50V,  $R_G$ =25 ohm, Starting  $T_J$ =25°C

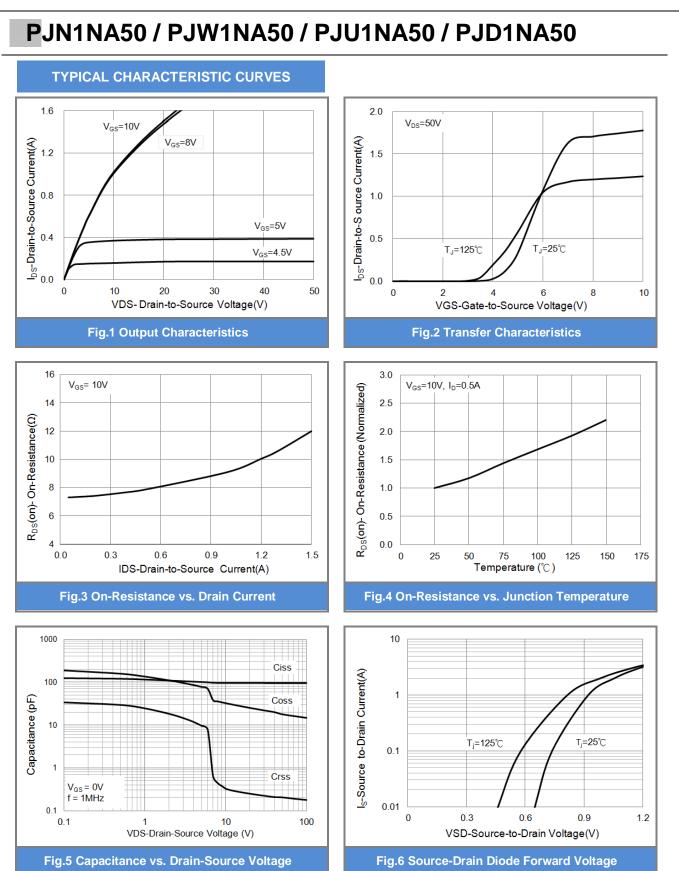
2. Pulse width</br>

3. Essentially independent of operating temperature typical characteristics.

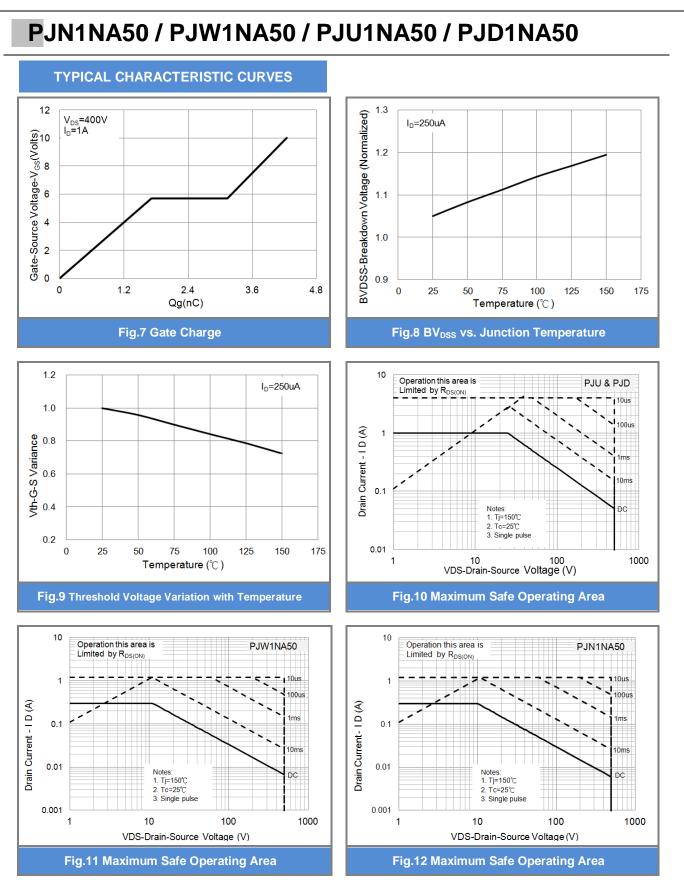
4. R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.

5. Guaranteed by design, not subject to production testing



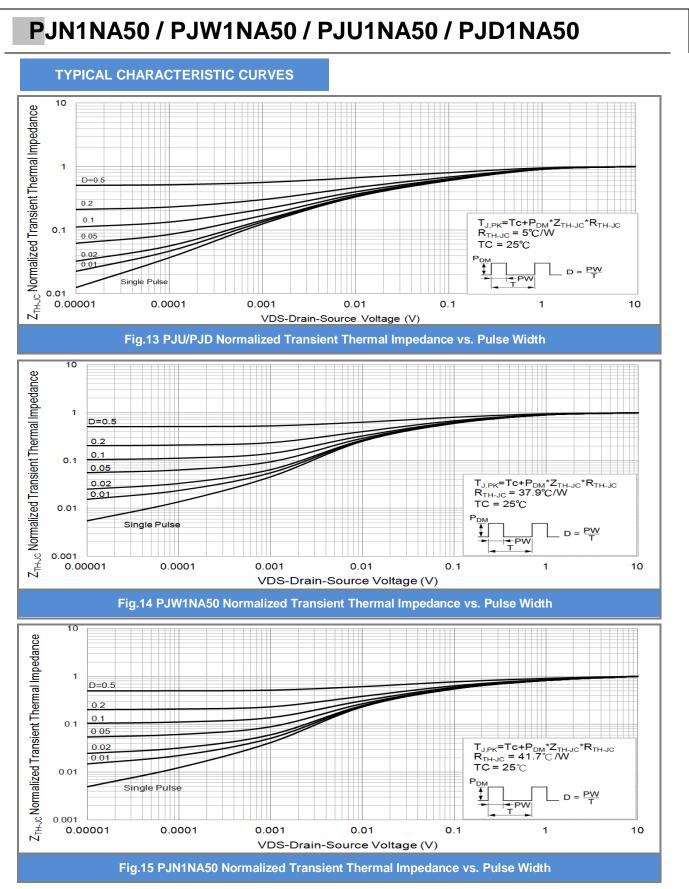










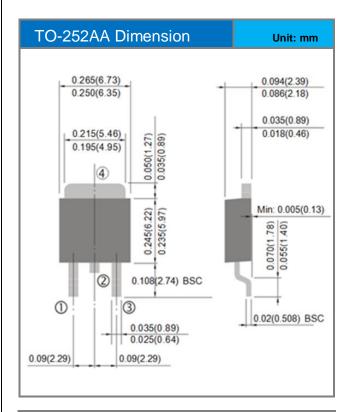


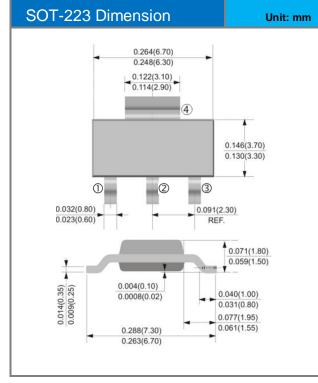
January 13,2016-REV.02

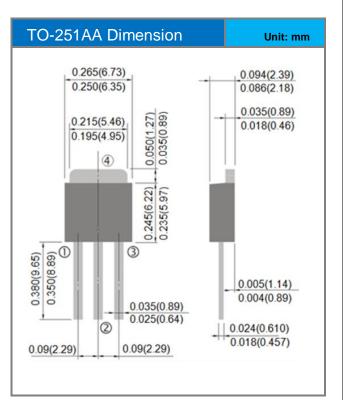


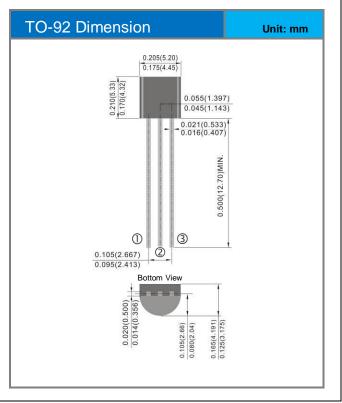


#### Packaging Information













#### PART NO PACKING CODE VERSION

Part No Packing Code	Package Type Packing type		Marking	Version	
PJU1NA50_T0_00001	TO-251AA	80pcs / Tube	U1NA50	Halogen free	
PJD1NA50_L2_00001	TO-252AA	3,000pcs / 13" reel	D1NA50	Halogen free	
PJW1NA50_R2_00001	SOT-223	2,500pcs / 13" reel	1NA50	Halogen free	
PJN1NA50_B0_00001	TO-92	1000pcs / bag	1NA50	Halogen free	
PJN1NA50_A0_00001	TO-92 AMMO	2000pcs / box	1NA50	Halogen free	

### For example :

RB500V-40\_R2\_00001

Part No.

Version code means HF

Packing size code means 13"

-• Packing type means T/R

Packing Code XX					Version Code XXXXX		
1 <sup>st</sup> Code	Packing size code	2 <sup>nd</sup> Code	HF or RoHS	1 <sup>st</sup> Code	2 <sup>nd</sup> ~5 <sup>th</sup> Code		
Α	N/A	0	HF	0	serial number		
R	7"	1	RoHS	1	serial number		
В	13"	2					
т	26mm	x					
S	52mm	Y					
L	PANASERT T/B CATHODE UP (PBCU)	U					
F	PANASERT T/B CATHODE DOWN (PBCD)	D					
	1 <sup>st</sup> Code A R B T S L	1st CodePacking size codeAN/AR7"B13"T26mmS52mmLPANASERT T/B CATHODE UP (PBCU)	1st Code2nd CodeAN/A0R7"1B13"2T26mmXS52mmYLPANASERT T/B CATHODE UP (PBCU)D	1st CodePacking size code2nd CodeHF or RoHSAN/A0HFR7"1RoHSB13"21T26mmX1S52mmY1LPANASERT T/BUL	1st CodePacking size code2nd CodeHF or RoHS1st CodeAN/A0HF0R7"1RoHS1B13"211T26mmX11S52mmY11LPANASERT T/B CATHODE UP (PBCU)D11		





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